

3.0mmx1.5mm SMD CHIP LED LAMP

Part Number: KPL-3015ZGC

Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE **SENSITIVE**

DEVICES

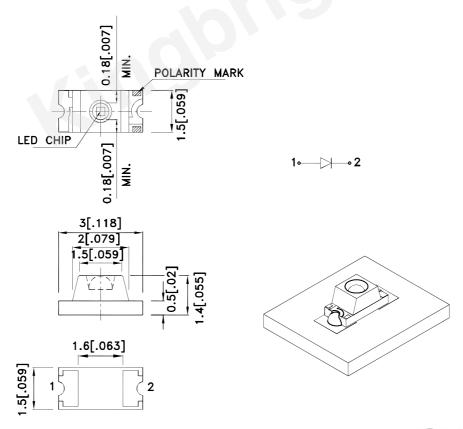
Features

- 3.0mmx1.5mm SMT LED, 1.4mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Descriptions

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mo @ 20	,	Viewing Angle [1]
		-	Min.	Тур.	201/2
KPL-3015ZGC	Green (InGaN)	Water Clear	500	800	70°

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	IF=20mA
lr	Reverse Current	Green		50	uA	V _R =5V

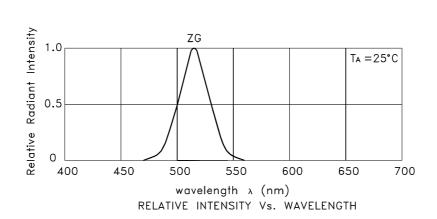
- Notes:
 1. Wavelength: +/-1nm.
 2. Forward Voltage: +/-0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

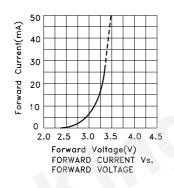
Parameter Green Power dissipation 102.5 DC Forward Current 25 Peak Forward Current [1] 150 Reverse Voltage 5			
DC Forward Current 25 Peak Forward Current [1] 150 Reverse Voltage 5	Units		
Peak Forward Current [1] 150 Reverse Voltage 5	mW		
Reverse Voltage 5	mA		
	mA		
	V		
Operating Temperature -40°C To +85°C	-40°C To +85°C		
Storage Temperature -40°C To +85°C	-40°C To +85°C		

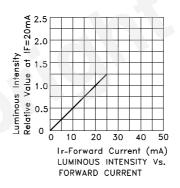
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

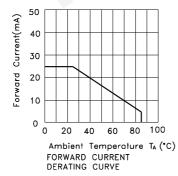
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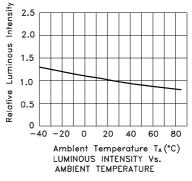


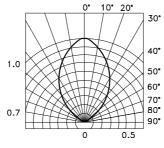
Green KPL-3015ZGC











SPATIAL DISTRIBUTION

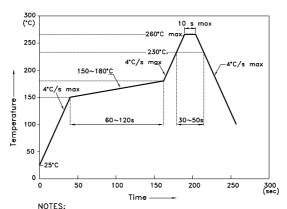
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KPL-3015ZGC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

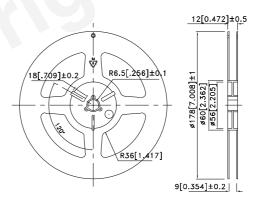
 3.Number of reflow process shall be 2 times or less.

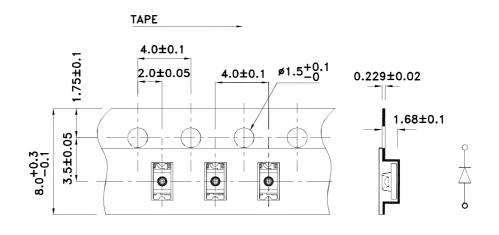
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

4.4 1.6

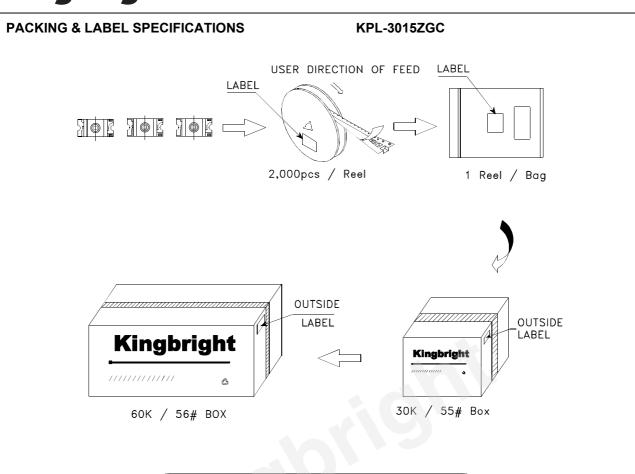
Tape Dimensions (Units: mm)

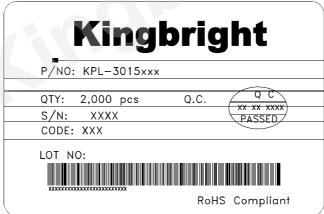
Reel Dimension





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